Docket No. AMENDMENT TRANSMITTAL LETTER 8733.599.00 Application No. Filing Date Examiner Art Unit 2814 09/497,508 February 4, 2000 W. S. Louie Applicant(s): Jin JANG et al. Invention: POLYCRYSTALLINE SILICON FILM CONTAINING Ni TO THE COMMISSIONER FOR PATENTS Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below. **CLAIMS AS AMENDED** Claims Highest Remaining Number Number After Previously **Extra Claims** Amendment Paid Present Rate **Total Claims** 18.00 0.00 19 20 Х Independent 2 3 0 Х 86.00 0.00 Claims Multiple Dependent Claims (check if applicable) Other fee (please specify): TOTAL ADDITIONAL FEE FOR THIS AMENDMENT: \$0.00 Small Entity x Large Entity No additional fee is required for this amendment. Please charge Deposit Account No. in the amount of \$ A duplicate copy of this sheet is enclosed. X A check in the amount of \$ \$0.00 to cover the filing fee is enclosed. Payment by credit card. Form PTO-2038 is attached. X The Director is hereby authorized to charge and credit Deposit Account No. 50-0911 as described below. A duplicate copy of this sheet is enclosed. Credit any overpayment. Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17. August 23, 2004 Dated: Rebecca Goldman Rudich Attorney Reg. No.: 41,786 MCKENNA LONG & ALDRIDGE LLP

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Docket No.: 8733.213.00-US

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Jin Jang et al.

Confirmation No.: 7572

Application No.: 09/497,508

Art Unit: 2814

Filed: February 4, 2000

Examiner: W. S. Louie

For: POLYCRYSTALLINE SILICON FILM

Customer No.: 30827

CONTAINING Ni

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated June 1, 2004 (Paper No. 0504), please amend the above-identified U.S. patent application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.